

Description

The SI7309DN-T1-E3 uses advanced trench technology

to provide excellent $R_{\text{DS}(\text{ON})},$ low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = -60V I_D =-20 A

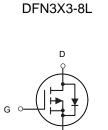
 $R_{DS(ON)} < 60m\Omega @ V_{GS} = -10V$

Application

Battery protection

Load switch Uninterruptible power supply

Package Marking and Ordering Information



Pin '

P-Channel MOSFET

Product ID	Pack	Brand	Qty(PCS)
SI7309DN-T1-E3	DFN3X3-8L	HXY MOSFET	5000

Absolute Maximum Ratings (TC=25°C unless otherwise specified)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	-60	V
VGS	Gate-Source Voltage	±20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ -10V ¹	-20	A
I _D @Tc=100°C	Continuous Drain Current, V _{GS} @ -10V ¹	-12	A
IDM	Pulsed Drain Current ²	-30	А
EAS	Single Pulse Avalanche Energy ³	18.1	mJ
IAS	Avalanche Current	-13	А
P _D @T _C =25℃	Total Power Dissipation ⁴	25	W
PD@TA=25°C	Total Power Dissipation ⁴	2	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C



P-Channel Enhancement Mode MOSFET

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-60			V
∆BV _{DSS} /∆T	BV _{DSS} Temperature Coefficient	Reference to $25^{\circ}C$, I _D =-1mA		-0.023		V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-10A		49	60	mΩ
	Static Drain-Source On-Resistance	V _{GS} =-4.5V , I _D =-6A		61	75	1112.2
V _{GS(th)}	Gate Threshold Voltage		-1.2		-2.5	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	—V _{GS} =V _{DS} , I _D =-250uA		4		mV/°C
		V _{DS} =-24V , V _{GS} =0V , T _J =25°C			-1	uA
IDSS	I_{DSS} Drain-Source Leakage Current $V_{DS}=-24V$, $V_{GS}=0V$, $T_{J}=55^{\circ}C$	V _{DS} =-24V , V _{GS} =0V , T _J =55°C			-5	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-15A		12		S
Qg	Total Gate Charge (-4.5V)			6.1		nC
Q_gs	Gate-Source Charge	V _{DS} =-15V , V _{GS} =-4.5V , I _D =-15A		3.1		
Q_gd	Gate-Drain Charge			1.8		
T _{d(on)}	Turn-On Delay Time			2.6		
Tr	Rise Time	V_{DD} =-15V , V_{GS} =-10V , R_{G} =3.3 Ω ,		8.6		
T _{d(off)}	Turn-Off Delay Time	 I _D =-15A		33.6		ns
T _f	Fall Time			6		
Ciss	Input Capacitance			585		
C _{oss}	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		100		pF
Crss	Reverse Transfer Capacitance			85		
ls	Continuous Source Current ^{1,5}				-20	Α
I _{SM}	Pulsed Source Current ^{2,5}	$V_G=V_D=0V$, Force Current			-30	Α
V_{SD}	Diode Forward Voltage ²	V_{GS} =0V , I_{S} =-1A , T_{J} =25 $^{\circ}$ C			-1.2	V
t _{rr}	Reverse Recovery Time	IF=-15A , dI/dt=100A/μs ,		6.1		nS
Qrr	Reverse Recovery Charge	T _J =25°C		1.4		nC

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Note :

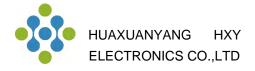
1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is V_{DD} =-25V, V_{GS} =-10V, L=0.1mH, I_{AS} =-19A

4.The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.



SI7309DN-T1-E3 P-Channel Enhancement Mode MOSFET

Typical Characteristics

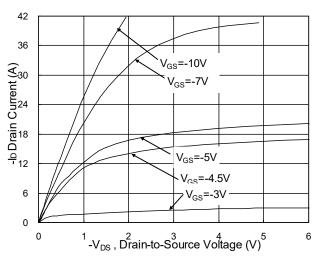


Fig.1 Typical Output Characteristics

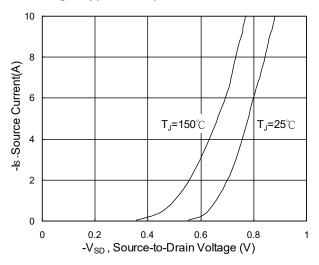


Fig.3 Forward Characteristics Of Reverse

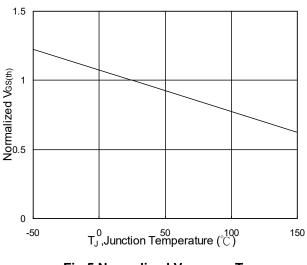


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

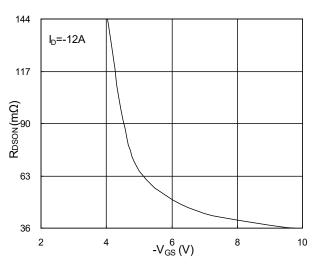


Fig.2 On-Resistance v.s Gate-Source

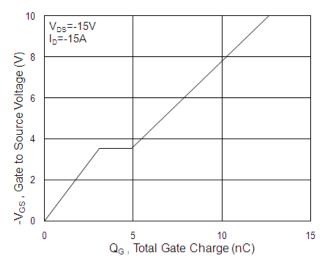


Fig.4 Gate Charge Characteristics

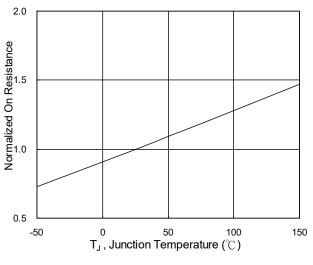
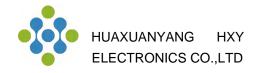
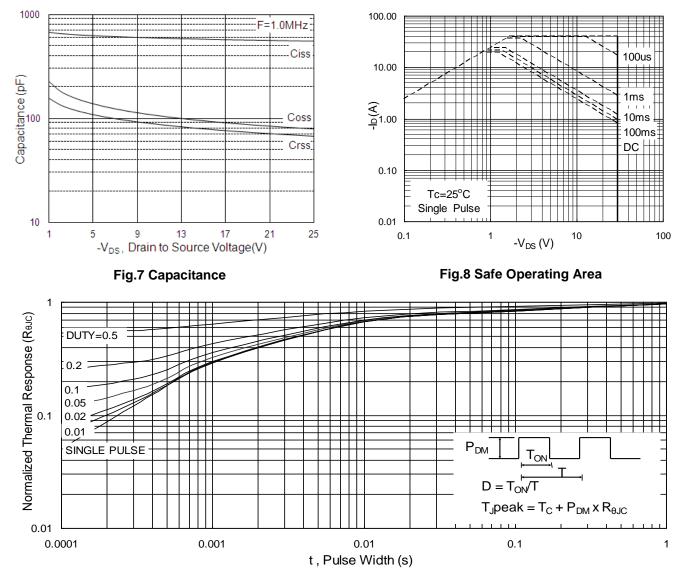


Fig.6 Normalized R_{DSON} vs. T_{J}







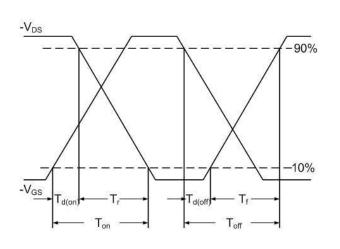
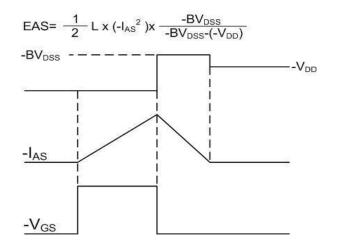


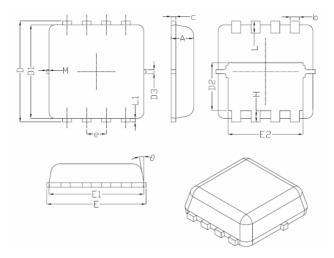
Fig.10 Switching Time Waveform







DFN3X3-8L Package Information



Sumbal	Dimensions In Millimeters		
Symbol —	Min.	Nom.	Max.
A	0.70	0.75	0.80
b	0.25	0.30	0.35
С	0.10	0.15	0.25
D	3.25	3.35	3.45
D1	3.00	3.10	3.20
D2	1.48	1.58	1.68
D3	-	0.13	-
E	3.20	3.30	3.40
E1	3.00	3.15	3.20
E2	2.39	2.49	2.59
e	0.65BSC		
Н	0.30	0.39	0.50
L	0.30	0.40	0.50
L1	-	0.13	-
Μ	*	*	0.15
θ		10 [°]	12 [°]



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